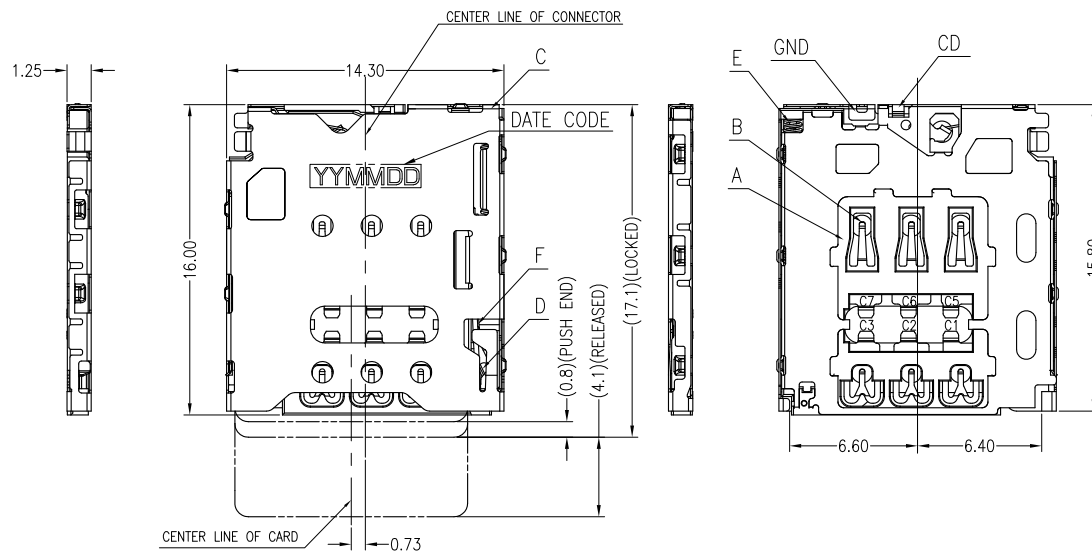
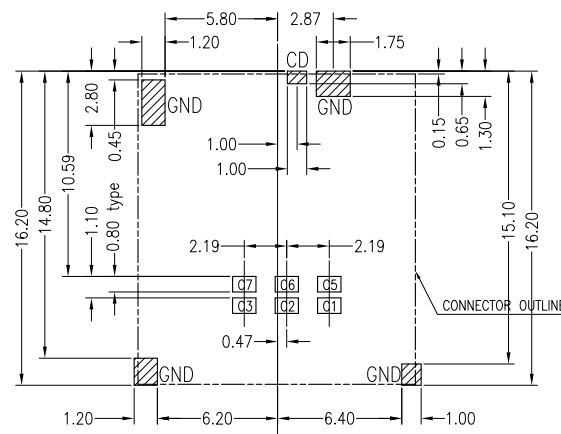


Micro SIM card
Thickness:0.76±0.08



RECOMMENDED P.C.B. LAYOUT
TOLERANCE (TOP VIEW) ±0.05mm

SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
 - CURRENT RATING: 1A .
 - DIELECTRIC WITHSTANDING VOLTAGE:500V R.M.S MIN;
 - INSULATION RESISTANCE: 500MΩ MIN.
 - CONTACT RESISTANCE:30mΩ MAX.(INITIAL)
- LIFE TEST: 1500 CYCLES .
- OTHER GENERAL SPEC. TO REFER "NANO SIM CARD SPEC".
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT:
- HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING:
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.
- PACKAGING: TAPE & REEL.

SIM CARD DETECT

CD	GND	CD	GND
CARD EJECTED		CARD INSERTED	

F	LINK	1	STAINLESS STEEL Ø0.25	
E	SPRING	1	SWP	NICKEL PLATING OVER ALL
D	SLIDE	1	HIGH TEMP. THERMOPLASTIC UL 94V-0	BLACK
C	SHELL	1	STAINLESS STEEL,0.10T	NICKEL PLATING OVER ALL
B	CONTACT	1	COPPER ALLOY,0.10T	GOLD FLASH ON CONTACT AREA AND SOLDER AREA 50u"MIN NICKEL UNDER-PLATED
A	HOUSING	1	HIGH TEMP. THERMOPLASTIC UL 94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

RoHS Compliant

MORETHANALL
PCB CONNECTORS
Cable ASSEMBLIES

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DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

SCALE 1 : 1

DATE

SIZE A4

TOLERANCES ARE

X. ± 0.50
.X ± 0.30
.XX ± 0.20
.XXX ±
ANG ±

PPOJECTION

照片框

ORDER INFORMATION

MISCP-W0112XA-06-LF

SERIES

90°SMT

LEADFREE
06WAY
SWITCH CLOSED
NON POST
HIGH 1.25mm
PAD TO PAD 1.10mm

DESCRIPTION: H1.25PUSH-SIM-CARD